

Title (en)  
SUPPORT DEVICE FOR MONOLITHICALLY INTEGRATED CIRCUITS

Title (de)  
TRAGEREINRICHTUNG FUR MONOLITHISCH INTEGRIERTE SCHALTUNGEN

Title (fr)  
DISPOSITIF DE SUPPORT POUR CIRCUITS MONOLITHIQUEMENT INTEGRES

Publication  
**EP 1552558 A1 20050713 (DE)**

Application  
**EP 03775171 A 20031006**

Priority  
• DE 10247075 A 20021009  
• EP 0311006 W 20031006

Abstract (en)  
[origin: WO2004036646A1] The invention relates to a support device (1) for a monolithically integrated circuit with connecting areas, which are provided in the form of platforms (2, 2'), for bondable contacts (5, 6). Said platforms (2, 2') are elevated with regard to a chip contacting area on the support device (1) and have steep flanks (3).

IPC 1-7  
**H01L 23/495**

IPC 8 full level  
**H01L 23/495** (2006.01)

CPC (source: EP KR US)  
**H01L 23/13** (2013.01 - KR); **H01L 23/495** (2013.01 - KR); **H01L 23/49503** (2013.01 - EP US); **H01L 23/50** (2013.01 - KR); **H01L 24/49** (2013.01 - EP US); **H01L 24/45** (2013.01 - EP US); **H01L 24/48** (2013.01 - EP US); **H01L 2224/05599** (2013.01 - EP US); **H01L 2224/45144** (2013.01 - EP US); **H01L 2224/48247** (2013.01 - EP US); **H01L 2224/49111** (2013.01 - EP US); **H01L 2224/49171** (2013.01 - EP US); **H01L 2224/85399** (2013.01 - EP US); **H01L 2924/00014** (2013.01 - EP US); **H01L 2924/01004** (2013.01 - US); **H01L 2924/01005** (2013.01 - EP US); **H01L 2924/01029** (2013.01 - EP US); **H01L 2924/01033** (2013.01 - EP US); **H01L 2924/01047** (2013.01 - EP US); **H01L 2924/01078** (2013.01 - EP US); **H01L 2924/01079** (2013.01 - EP US); **H01L 2924/01082** (2013.01 - EP US); **H01L 2924/014** (2013.01 - EP US); **H01L 2924/14** (2013.01 - EP US); **H01L 2924/181** (2013.01 - EP US); **H01L 2924/30107** (2013.01 - EP US)

Citation (search report)  
See references of WO 2004036646A1

Citation (examination)  
• JP H02285665 A 19901122 - NEC CORP  
• JP S647626 A 19890111 - NEC CORP

Designated contracting state (EPC)  
DE FR GB IT NL

DOCDB simple family (publication)  
**WO 2004036646 A1 20040429**; DE 10247075 A1 20040422; EP 1552558 A1 20050713; JP 2006503427 A 20060126; JP 4550580 B2 20100922; KR 101003061 B1 20101222; KR 20050053747 A 20050608; US 2006151772 A1 20060713

DOCDB simple family (application)  
**EP 0311006 W 20031006**; DE 10247075 A 20021009; EP 03775171 A 20031006; JP 2004544075 A 20031006; KR 20057006068 A 20031006; US 53114105 A 20050829